

Discrete POWER & Signal **Technologies**

FDH / FDLL 600





LL-34 THE PLACEMENT OF THE EXPANSION GAP HAS NO RELATIONSHIP TO THE LOCATION OF THE CATHODE TERMINAL

COLOR BAND MARKING DEVICE 1ST BAND 2ND BAND FDLL600 RED WHITE

High Conductance Ultra Fast Diode Sourced from Process 1R. See MMBD1201-1205 for characteristics. Absolute Maximum Ratings* TA = 25°C unless otherwise noted					
Symbol	Parameter	Value	Units		
W _{IV}	Working Inverse Voltage	50	V		
Io	Average Rectified Current	200	mA		
I _F	DC Forward Current	400	mA		
i _f	Recurrent Peak Forward Current	600	mA		
i _{f(surge)}	Peak Forward Surge Current Pulse width = 1.0 second Pulse width = 1.0 microsecond	1.0 4.0	A A		
T _{stg}	Storage Temperature Range	-65 to +200	°C		
T _J	Operating Junction Temperature	175	°C		

^{*}These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

NOTES:

- 1) These ratings are based on a maximum junction temperature of 200 degrees C.

 2) These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

Thermal Characteristics

TA = 25°C unless otherwise noted

Symbol	Characteristic	Мах	Units
		FDH/FDLL 600	
P_D	Total Device Dissipation	500	mW
	Derate above 25°C	3.33	mW/°C
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	300	°C/W

High Conductance Ultra Fast Diode

(continued)

Electrical Characteristics

TA = 25°C unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Max	Units
B _V	Breakdown Voltage	$I_R = 5.0 \mu A$	75		V
I _R	Reverse Current	V _R = 50 V V _R = 50 V, T _A = 150°C		100 100	nA μA
V _F	Forward Voltage	I _F = 1.0 mA I _F = 10 mA I _F = 50 mA I _F = 100 mA I _F = 200 mA		650 790 860 920 1.0	mV mV mV mV
Co	Diode Capacitance	$V_R = 0, f = 1.0 \text{ MHz}$		2.5	pF
T_RR	Reverse Recovery Time	$\begin{aligned} I_F &= I_R = 10 \text{ mA}, \ I_{ff} = 1.0 \text{ mA}, \\ R_L &= 100 \ \Omega \\ I_F &= I_R = 200 \text{ mA}, \ I_{ff} = 20 \text{ mA}, \\ R_L &= 100 \ \Omega \end{aligned}$		4.0 6.0	nS nS



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Definition of Terms

Datasheet Identification	Product Status	Definition
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